

# SMAJ-E Series









#### **Maximum Ratings and Thermal Characteristics** (T<sub>a</sub>=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation at $T_A$ =25°C by 10/1000 $\mu$ s Waveform (Fig.2)(Note 1), (Note 2)	P <sub>PPM</sub>	400	W
Power Dissipation on Infinite Heat Sink at $T_L$ =50°C	P <sub>D</sub>	3.3	W
Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 3)	I <sub>FSM</sub>	60	А
Maximum Instantaneous Forward Voltage at 25A for Unidirectional Only	V <sub>F</sub>	3.5	V
Operating Temperature Range	T <sub>J</sub>	-65 to 150	°C
Storage Temperature Range	T <sub>STG</sub>	-65 to 175	°C
Typical Thermal Resistance Junction to Lead	R <sub>eJL</sub>	30	°C/W
Typical Thermal Resistance Junction to Ambient	R <sub>eJA</sub>	120	°C/W

- 1. Non-repetitive current pulse, per Fig.4 and derated above  $T_{_{\rm J}}$  (initial) =25°C per Fig. 3.
- 2. Mounted on 5.0x5.0mm copper pad to each terminal.
- 3. Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional

#### **Description**

The SMAJ-E series is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

#### **Features**

- Excellent clamping capability
- For surface mounted applications to optimize board space
- Low profile package
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- IEC-61000-4-2 ESD 30kV(Air), 30kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2
- EFT protection of data lines in accordance with IEC 61000-4-4
- Built-in strain relief
- 400W Peak pulse power capability at 10/1000µs waveform, repetition rate (duty cycle): 0.01%

- Fast response time: typically less than 1.0ps from 0 Volts to  $V_{\rm RR}$  min
- Glass passivated junction
- Low inductance
- High temperature to reflow soldering guaranteed: 260°C/40sec
- V<sub>BR</sub> @ T<sub>J</sub>= V<sub>BR</sub>@25°C  $\times (1 + \alpha T \times (T_1 - 25))$ ( $\alpha$ T:Temperature Coefficient, typical value is 0.1%)
- EPI silicon technology
- Meet MSL level1, per J-STD-020C, LF maximun peak of 260°C
- Matte tin lead-free Plated
- Halogen free and RoHS compliant
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)

#### **Functional Diagram**



#### **Applications**

TVS devices are ideal for the protection of I/O Interfaces, V<sub>CC</sub> bus and other vulnerable circuits used in Telecom, Computer, Industrial and Consumer electronic applications.

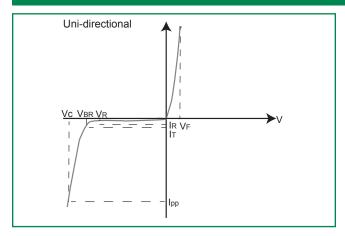
# TVS Diodes Surface Mount – 400W > SMAJ-E Series

#### Electrical Characteristics (T<sub>a</sub>=25°C unless otherwise noted)

Part Number (Uni)	Marking	Reverse Stand off Voltage V <sub>R</sub>	Breakdown Voltage V <sub>BR</sub> (Volts) @ I <sub>T</sub>		Test Current I <sub>T</sub>	Maximum Clamping Voltage V <sub>c</sub> @	Cullentipp	Maximum Reverse Leakage I <sub>R</sub> @ V <sub>R</sub>
(31)		(Volts)	MIN	MAX	(mA)	(V)	(A)	(μA)
SMAJ300A-E	XE	300	335.0	371.0	1	486.0	0.80	1
SMAJ350A-E	XG	350	391.0	432.0	1	567.0	0.70	1
SMAJ400A-E*	XK	400	447.0	494.0	1	648.0	0.60	1
SMAJ450A-E*	XM	440	492.0	543.0	1	713.0	0.60	1
SMAJ500A-E*	XN	500	558.0	618.0	1	810.0	0.50	1
SMAJ550A-E*	XP	550	614.0	680.0	1	891.0	0.46	1
SMAJ600A-E*	XR	600	670.0	741.0	1	971.0	0.42	1
SMAJ650A-E*	XS	650	726.0	803.0	1	1052.0	0.39	1
SMAJ700A-E*	XT	700	782.0	865.0	1	1133.0	0.36	1
SMAJ750A-E*	XU	750	837.0	927.0	1	1213.0	0.33	1
SMAJ850A-E*	XV	850	950.0	1050.0	1	1365.0	0.30	1

Note: for parts with \* are still under development

#### **I-V Curve Characteristics**



- $\mathbf{P}_{_{\text{PPM}}}$  Peak Pulse Power Dissipation Max power dissipation
- $\mathbf{V}_{\scriptscriptstyle{R}}$  Stand-off Voltage Maximum voltage that can be applied to the TVS without operation
- V<sub>BR</sub> Breakdown Voltage Maximum voltage that flows though the TVS at a specified test current (I<sub>x</sub>)
- **V**<sub>ε</sub> **Clamping Voltage** Peak voltage measured across the TVS at a specified Ippm (peak impulse current)
- I<sub>R</sub> Reverse Leakage Current -- Current measured at V<sub>R</sub>
- V<sub>F</sub> Forward Voltage Drop for Uni-directional



#### Ratings and Characteristic Curves (T<sub>a</sub>=25°C unless otherwise noted)

Figure 1 - TVS Transients Clamping Waveform

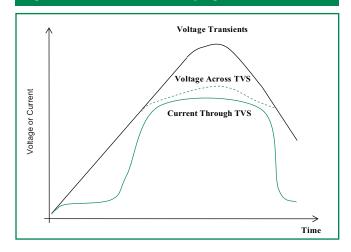


Figure 2 - Peak Pulse Power Rating Curve

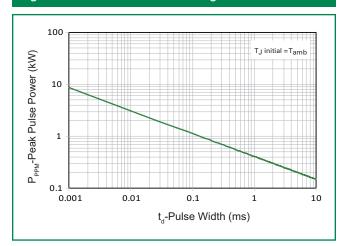


Figure 3 - Peak Pulse Power Derating Curve

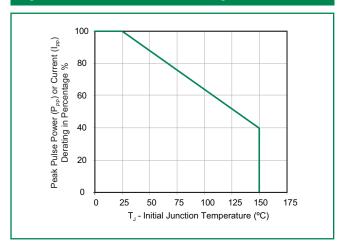


Figure 4 - Pulse Waveform

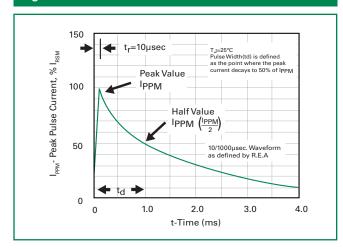


Figure 5 - Typical Junction Capacitance

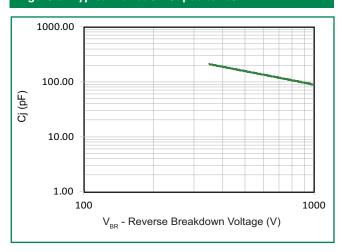


Figure 6 - Typical Transient Thermal Impedance

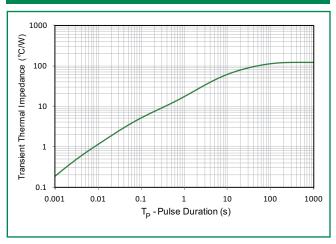




Figure 7 - Maximum Non-Repetitive Forward Surge Current Uni-Directional Only

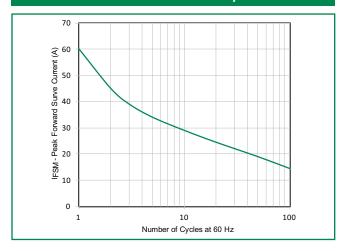
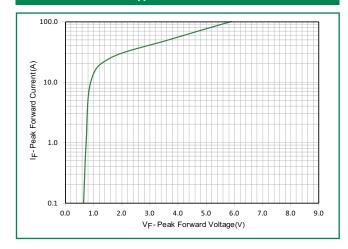
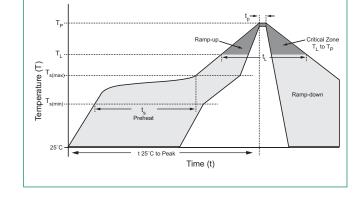


Figure 8 - Peak Forward Voltage Drop vs Peak Forward Current (Typical Values)



#### **Soldering Parameters**

Reflow Co	ndition	Lead-free assembly	
Pre Heat	-Temperature Min (T <sub>s(min)</sub> )	150°C	
	-Temperature Max (T <sub>s(max)</sub> )	200°C	
	-Time (min to max) (t <sub>s</sub> )	60 – 180 secs	
Average ra to peak	mp up rate (Liquidus Temp (T <sub>A</sub> )	3°C/second max	
T <sub>S(max)</sub> to T <sub>A</sub>	- Ramp-up Rate	3°C/second max	
Reflow	-Temperature (T <sub>A</sub> ) (Liquidus)	217°C	
	-Time (min to max) (t <sub>s</sub> )	60 – 150 seconds	
Peak Temp	erature (T <sub>P</sub> )	260 <sup>+0/-5</sup> °C	
Time withi Temperatu	n 5°C of actual peak re (t <sub>p</sub> )	20 - 40 seconds	
Ramp-dow	n Rate	6°C/second max	
Time 25°C	to peak Temperature (T <sub>P</sub> )	8 minutes Max.	
Do not exc	eed	260°C	



#### **Physical Specifications**

Weight	0.002 ounce, 0.061 gram
Case	JEDEC DO-214AC Molded Plastic over glass passivated junction
Polarity	Color band denotes cathode except Bipolar
Terminal	Matte Tin-plated leads, Solderable per JESD22-B102

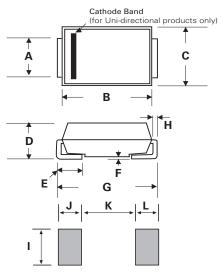
## **Environmental Specifications**

High Temp. Storage	JESD22-A103
нткв	JESD22-A108
Temperature Cycling	JESD22-A104
MSL	JEDEC-J-STD-020, Level 1
H3TRB	JESD22-A101
RSH	JESD22-A111



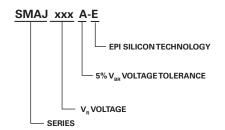
#### **Dimensions**

#### DO-214AC (SMA)

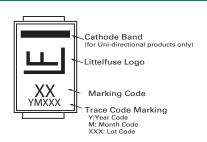


Discouries	Incl	nes	Millimeters		
Dimensions	Min	Max	Min	Max	
А	0.049	0.065	1.250	1.650	
В	0.157	0.181	3.990	4.600	
С	0.095	0.110	2.400	2.790	
D	0.075	0.090	1.900	2.290	
Е	0.030	0.060	0.780	1.520	
F	-	0.008	-	0.203	
G	0.189	0.208	4.800	5.280	
Н	0.006	0.012	0.152	0.305	
I	0.070	-	1.800	-	
J	0.082	-	2.100	-	
K	-	0.090	-	2.300	
L	0.082	-	2.100	-	

#### **Part Numbering System**



### **Part Marking System**



#### **Packaging**

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
SMAJxxxA-E	DO-214AC	5000	Tape & Reel - 12mm tape/13" reel	EIA STD RS-481

#### **Tape and Reel Specification**

